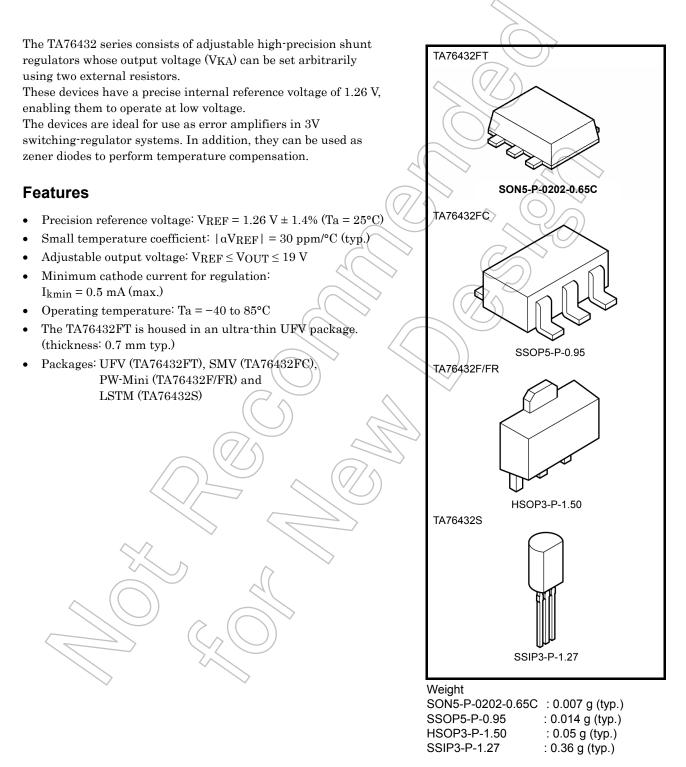
<u>TOSHIBA</u>

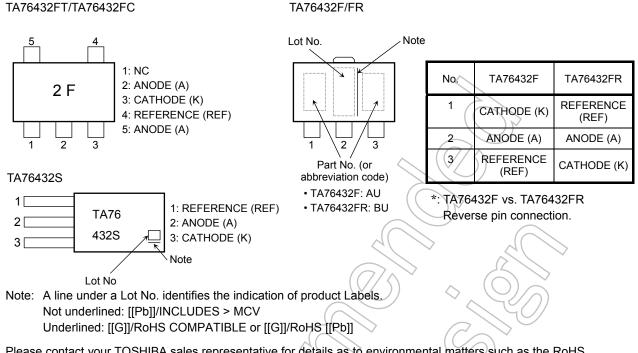
TOSHIBA Bipolar Linear Integrated Circuit Silicon Monolithic

TA76432FT,TA76432FC,TA76432F,TA76432FR,TA76432S

1.26V Adjustable High-Precision Shunt Regulators



Pin Assignment/Marking



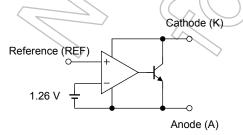
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

How to Order

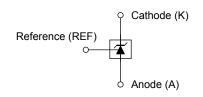
Product No.	Package Type	Packing Type and Capacity
TA76432FT (TE85L,F)	UFV (surface-mount type)	Embossed tape: 3000 pcs/tape
TA76432FC (TE85L,F)	SMV (surface-mount type)	Embossed tape: 3000 pcs/reel
TA76432F/FR(F)	PW-Mini (SOT-89)	On cut tape (TE12L,F): 100 pcs/tape section
TA76432F/FR (TE12L,F)	(surface-mount type)	Embossed tape: 1000 pcs/reel
TA76432S(F)	LSTM	Loose in bag: 200 pcs/bag
TA76432S (TPE6,F)	(lead type)	Radial tape: 2000 pcs/reel

Note: The lead pitch for the TA76432S(F) and TA76432S (TPE6,F) may vary.

Functional Block Diagram

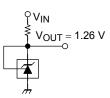


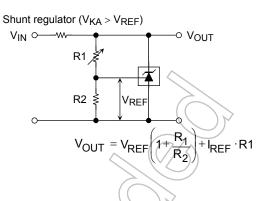
Circuit Symbol



Typical Application Circuits

1.26 V Reference ($V_{KA} = V_{REF}$)





Usage Precautions

- TA76432FT, TA76432FC, TA76432F/FR, TA76432S These products contain MOS elements. Please take care to avoid generating static electricity when handling these devices.
- (2) TA76432FT, TA76432FC, TA76432F/FR, TA76432S The oscillation frequency of these devices is determined by the value of the capacitor connected between the anode and the cathode. When establishing maximum operating condition parameters, please derate the absolute maximum rating values specified in these datasheets so as to allow an operational safety margin. Use of a laminated ceramic capacitor is recommended.
- (3) Precautions when handling anode pins of TA76432FT/TA76432FC Pin 2 and pin 5 should normally be shorted together. If only pin 5 is used, pin 2 should either be left open or always kept at a lower potential than pin 5. Do not leave pin 5 open and use pin 2 only.

Absolute Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Cathode voltage		V _{KA}	20	V	
Cathode current		١ _K	20	mA	
Cathode-anode reverse current		-IK	10	mA	
Reference voltage		V _{REF}	7	V	
Reference current		I _{REF}	50	μA	$(\bigcirc)^{2}$
Reference-anode rev	verse current	-I _{REF}	10	mA	
Power dissipation	TA76432FT		0.45 (Note 1)	4	
	TA76432FC	PD	0.2	w	
			0.38 (Note 2)		
	TA76432F/FR		0.5		
	TA76432S		0.8		
Thermal resistance	TA76432FT	R _{th}	277 (Note 1)	(7)	
	TA76432FC		625	$\lor \bigcirc$	
			328 (Note 2)	°C/W	
	TA76432F/FR		250		
	TA76432S		156	\rightarrow	
Operating temperatu	re	T _{opr}	-40 to 85	°C	(0/5)
Junction temperature		Tj	150	°C	
Storage temperature		T _{stg}	-55 to 150	∕ °c	

Note 1: Glass epoxy board mounting: 30 mm \times 30 mm \times 0.8 mmt (Cu pad area 35 mm²)

Note 2: Glass epoxy board mounting: $30 \text{ mm} \times 30 \text{ mm} \times 0.8 \text{ mmt}$ (Cu pad area 50 mm²)

Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges

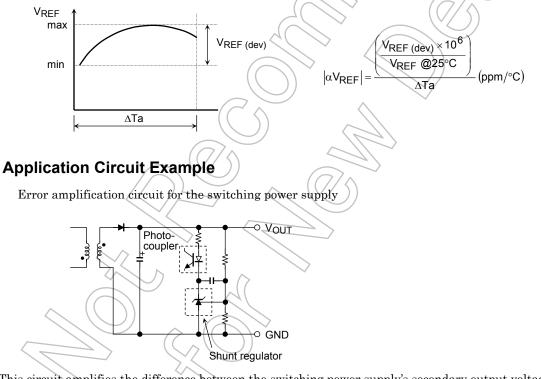
Characteristics	Symbol	Min	Тур.	Max	Unit
Cathode voltage	VKA	V _{REF}	—	19	V
Cathode current	(IK)	0.5	—	15	mA
Operating temperature	T _{opr}	-40	_	85	°C

Electrical Characteristics (Unless otherwise specified, $Ta = 25^{\circ}C$, $I_{K} = 5 \text{ mA}$)

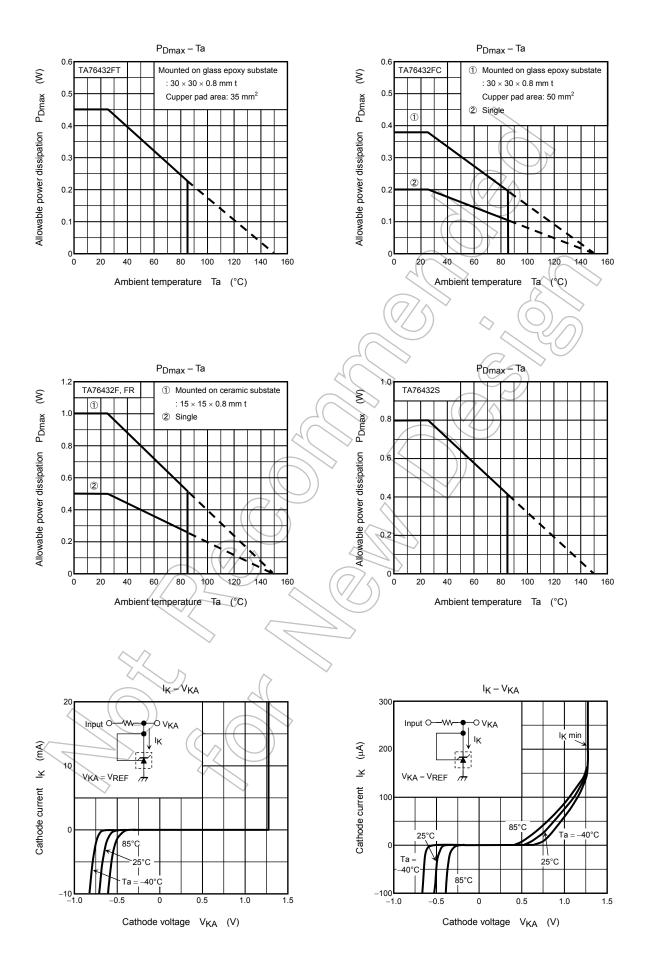
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Reference voltage	V _{REF}	V _{KA} = V _{REF}	1.242	1.26	1.278	V
Deviation of reference input voltage over temperature	V _{REF (dev)}	$0^{\circ}C \leq Ta \leq 85^{\circ}C, V_{KA} = V_{REF}$	X	3	15	mV
Ratio of change in reference input voltage to the change in cathode voltage	ΔV _{REF} /ΔV	$V_{REF} \le V_{KA} \le 5 V$	$(\square$	0.5	2.5	mV/V
		$5 V \leq V_{KA} \leq 19 V$	X	0.3	2.0	
Reference input current	I _{REF}	V _{KA} = V _{REF}	$\langle A \rangle$	2	4	μA
Deviation of reference input current over temperature	IREF (dev)	$\begin{array}{l} 0^{\circ}C \leq Ta \leq 85^{\circ}C, \ V_{KA} = V_{REF}, \\ R_{1} = 10 \ k\Omega, \ R_{2} = \infty \end{array}$	2	0.3	1.2	μA
Minimum cathode current for regulation	I _{Kmin}	V _{KA} = V _{REF}	_	0.2	0.5	mA
Off-State cathode current	I _{Koff}	V _{KA} = 19 V, V _{REF} = 0 V		A	1.0	μA
Dynamic impedance	Z _{KA}	$V_{KA} = V_{REF}, f \le 1 \text{ kHz},$ 0.5 mA $\le I_K \le 15 \text{ mA}$	-6	0.2	> 0.5	Ω

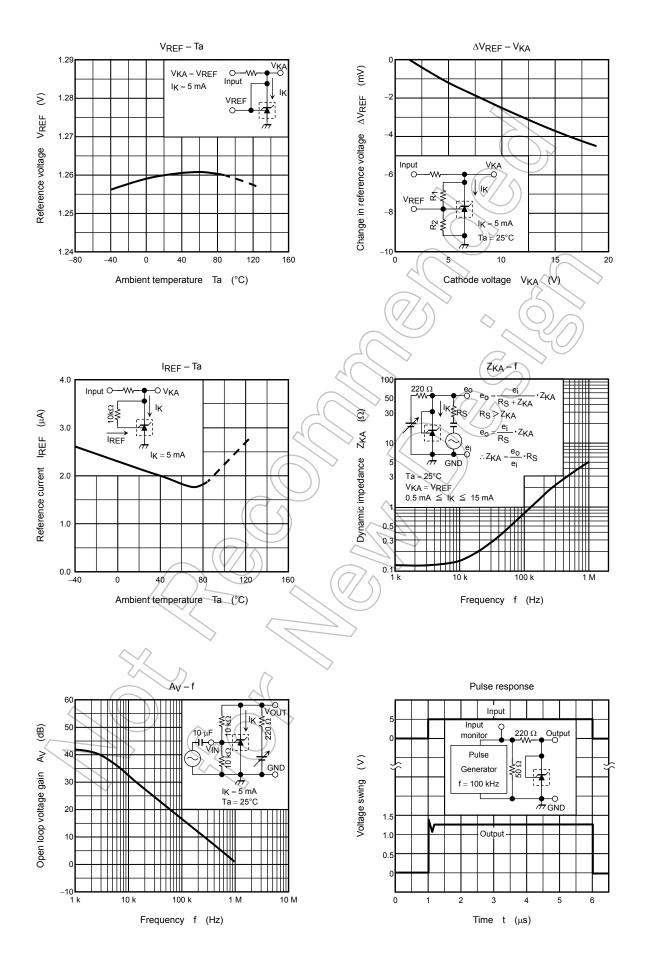
The deviation parameters $V_{REF (dev)}$ and $I_{REF (dev)}$ are defined as the maximum variation of the V_{REF} and I_{REF} over the rated temperature range.

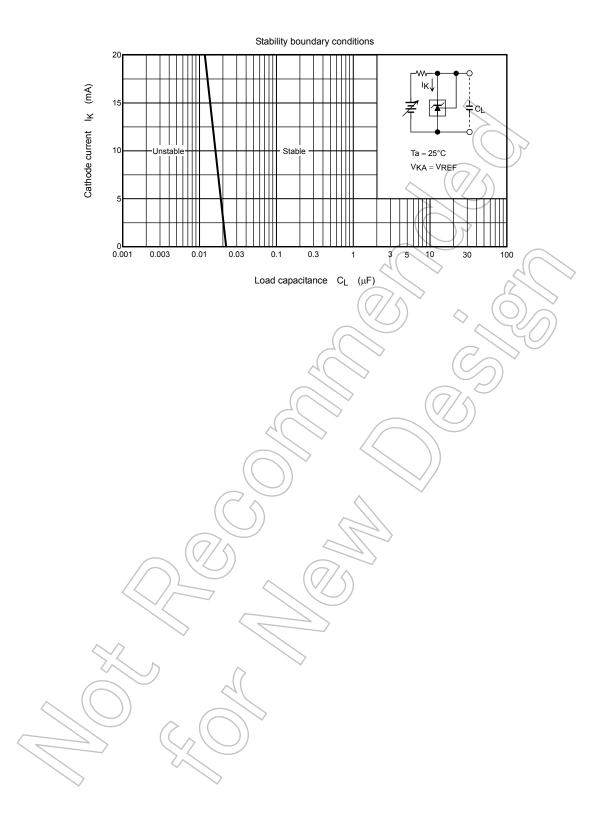
The average temperature coefficient of the VREF is defined as:



This circuit amplifies the difference between the switching power supply's secondary output voltage and the shunt regulator's reference voltage. It then feeds the amplified voltage back to the primary input voltage via the photocoupler.



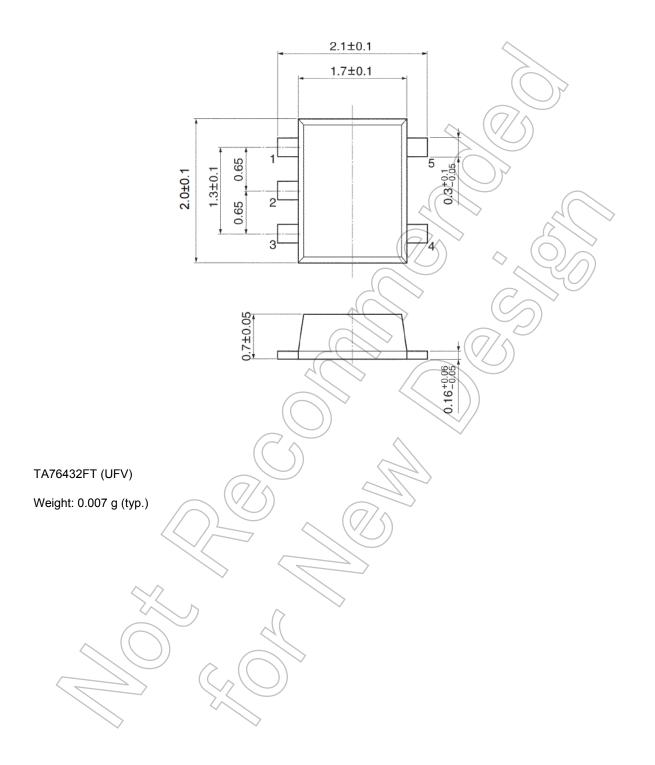




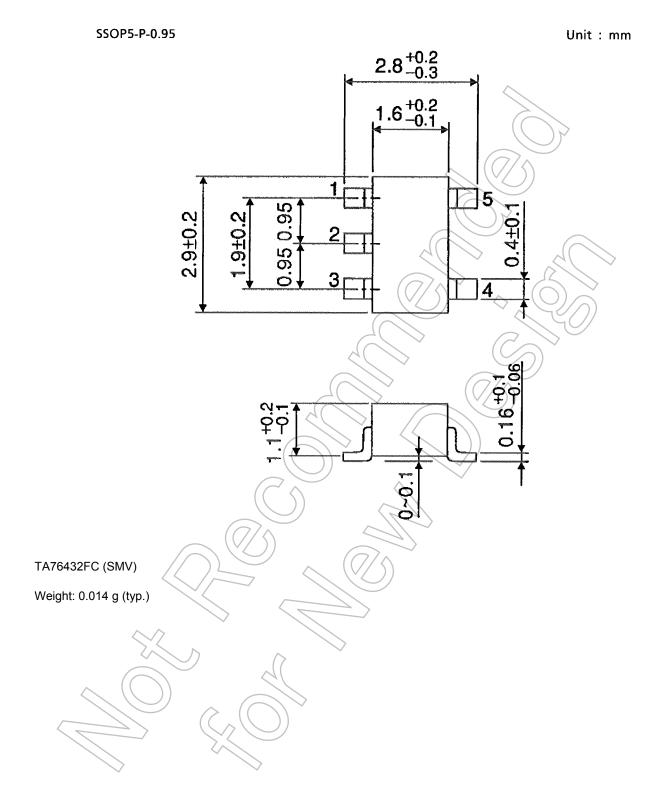
Package Dimensions

SON5-P-0202-0.65C

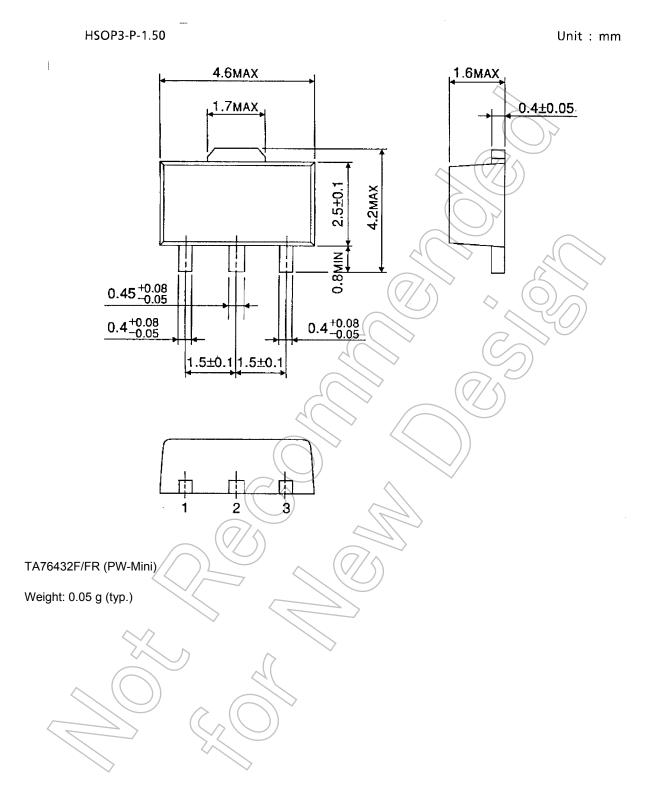
Unit: mm



Package Dimensions

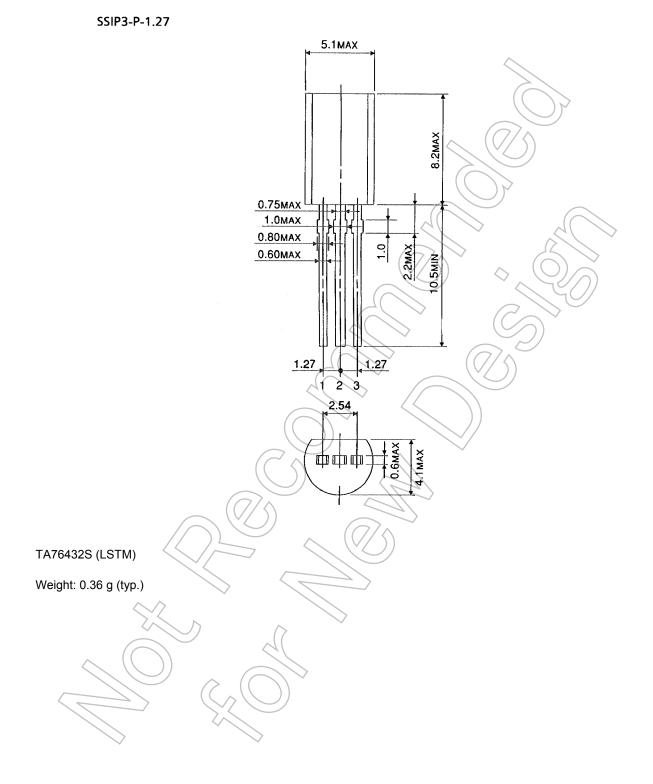


Package Dimensions



Package Dimensions

Unit : mm



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